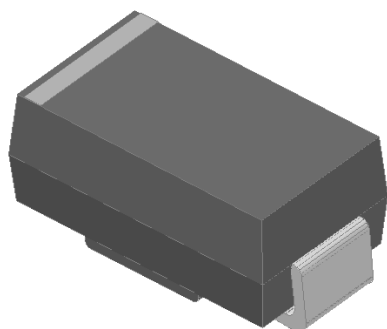


■ FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Super Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

■ TYPICAL APPLICATIONS

For use in high frequency rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

■ MECHANICAL DATA

- **Package:** DO-214AC (SMA)
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

■ MAXIMUM RATINGS (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	UG2AA	UG2BA	UG2CA	UG2DA	UG2FA	UG2GA	UG2HA	UG2JA
Device marking code			UG2AA	UG2BA	UG2CA	UG2DA	UG2FA	UG2GA	UG2HA	UG2JA
Repetitive peak reverse voltage	V _{RRM}	V	50	100	150	200	300	400	500	600
Average rectified output current @60Hz sine wave, Resistance load, TL (FIG.1)	I _O	A	2.0							
Surge (non-repetitive) forward current @ 60Hz Half-sine wave, 1 cycle, T _a =25°C	I _{FSM}	A	50							
Storage temperature	T _{stg}	°C	-55 ~ +150							
Junction temperature	T _j	°C	-55 ~ +150							

■ ELECTRICAL CHARACTERISTICS (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	UG2AA	UG2BA	UG2CA	UG2DA	UG2FA	UG2GA	UG2HA	UG2JA
Maximum instantaneous forward voltage drop per diode	V _F	V	I _F =2.0A	0.92				1.25		1.7	
Maximum reverse recovery time	T _{RR}	ns	I _F =0.5A, I _R =1.0A, I _{rr} =0.25A	25						35	
Maximum DC reverse current at rated DC blocking voltage per diode@ V _{RM} =V _{RRM}	I _{RRM}	μA	T _a =25°C	5							
			T _a =125°C	50							

■ THERMAL CHARACTERISTICS (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	UG2AA	UG2BA	UG2CA	UG2DA	UG2FA	UG2GA	UG2HA	UG2JA
Typical Thermal Resistance	R _{θJ-A}	°C/W	75 ¹⁾							
	R _{θJ-L}	°C/W	20 ¹⁾							

Note Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

■ CHARACTERISTICS (TYPICAL)

FIG.1: Io-TL Curve

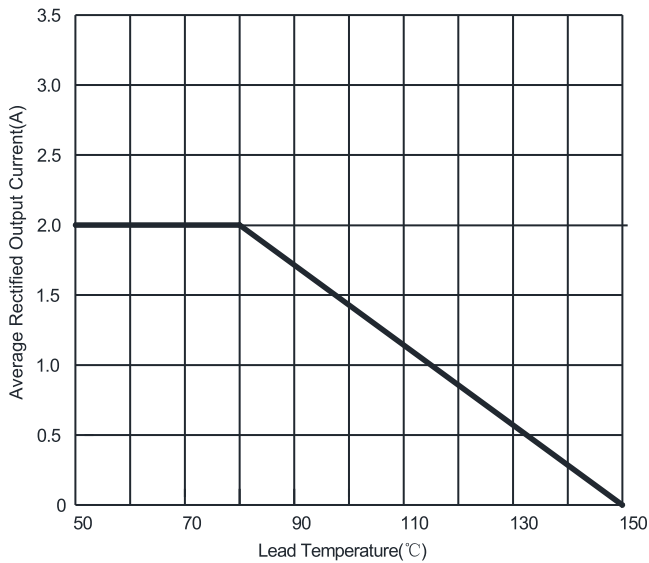


FIG2: Surge Forward Current Capability

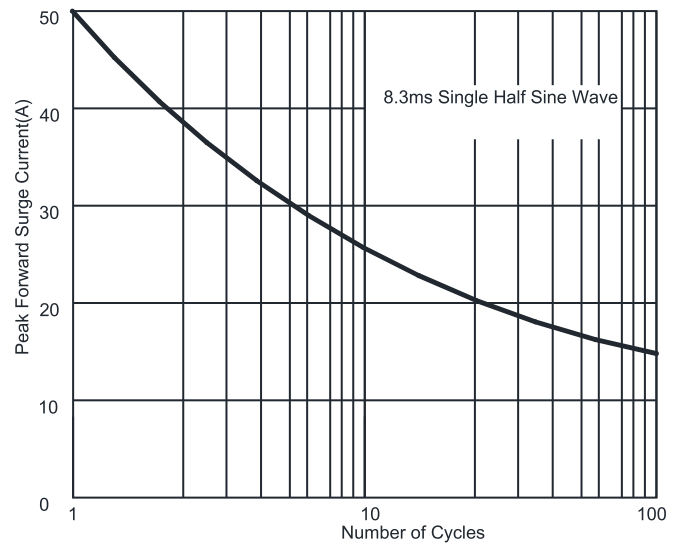


FIG.3: Typical Forward Characteristics

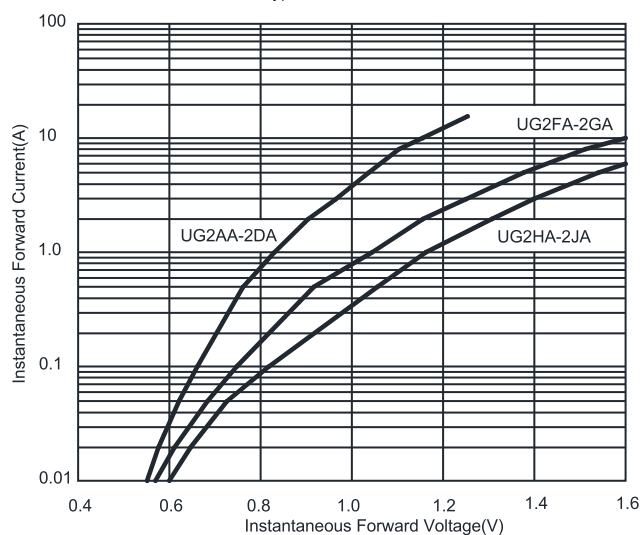


FIG4: Typical Reverse Characteristics

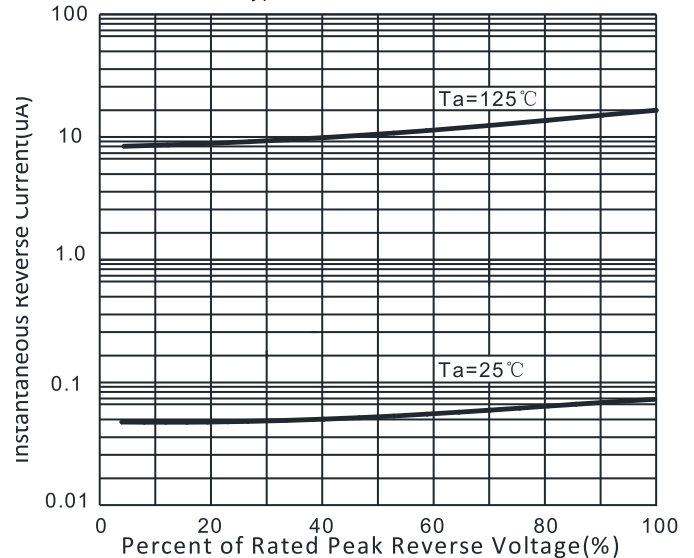
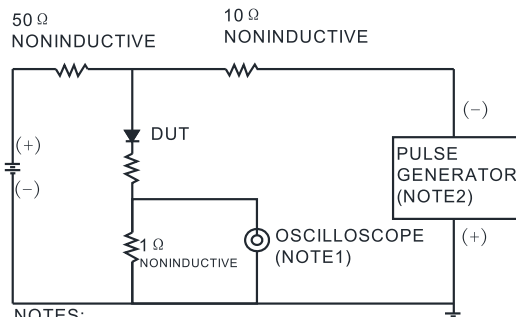
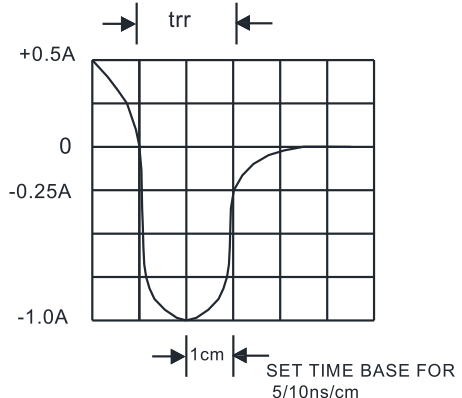


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time



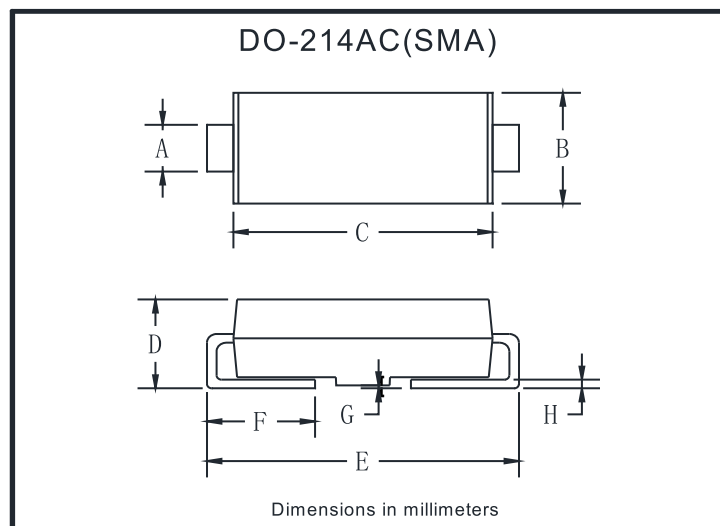
NOTES:
1. Rise Time=7ns max .Input Impedance=1MΩ 22pf
2. Rise Time=10ns max. Source Impedance=50Ω



■ PACKAGING INFORMATION

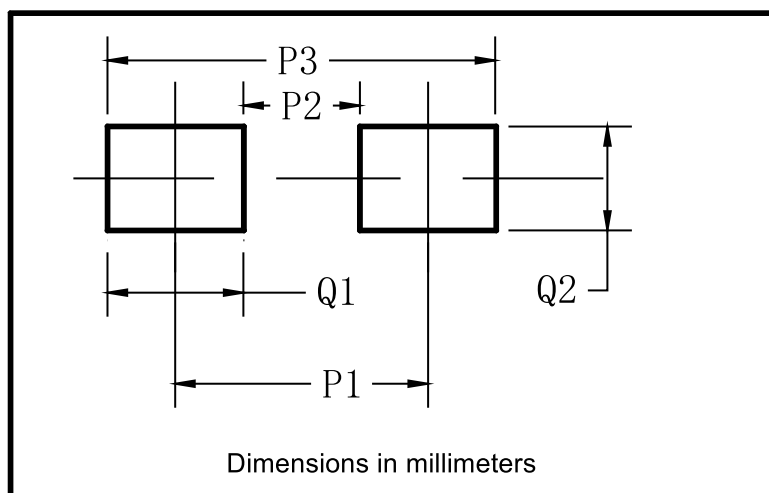
PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
UG2AA- UG2JA	F1	Approximate 0.059	5000	10000	80000	13" reel
UG2AA- UG2JA	F2	Approximate 0.059	7500	15000	120000	13" reel
UG2AA- UG2JA	F3	Approximate 0.059	7500	15000	60000	13" reel
UG2AA- UG2JA	F4	Approximate 0.059	1800	7200	57600	7" reel
UG2AA- UG2JA	F5	Approximate 0.059	2000	8000	64000	7" reel
UG2AA- UG2JA	F6	Approximate 0.059	5000	10000	100000	13" reel

■ OUTLINE DIMENSIONS



DO-214AC(SMA)		
Dim	Min	Max
A	1.25	1.58
B	2.40	2.83
C	4.25	4.75
D	1.90	2.30
E	4.93	5.28
F	0.76	1.41
G	0.08	0.20
H	0.15	0.31

■ SUGGESTED PAD LAYOUT



DO-214AC(SMA)	
Dim	Millimeters
P1	4.00
P2	1.50
P3	6.50
Q1	2.50
Q2	1.70